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Automotive PulseChip™ CAN chokes
2-Line EMI Suppression for CAN-Bus Networks



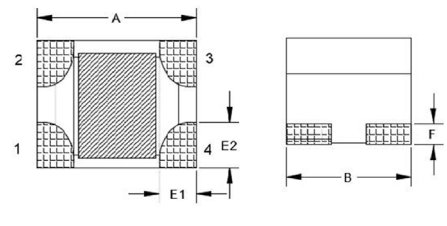
Features and Benefits:

- *PulseChip design meets AEC-Q200 Requirements*
- *Suppresses common mode noise without attenuating the signal*
- *Magnetically shielded versions for lower Rdc and higher current*
- *High-sided Metallization for improved solder join*
- *Supports CAN-Bus, A2B and other IVN high speed differential signal lines (LVDS)*

Electrical Specifications @ 25°C

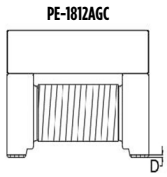
Part Number	Common Mode Impedance (10MHz)		Inductance (uH)	Standard Tolerance	RDC (Ω Max)	IDC (mA MAX)	Isolation Resistance (M Ω) Min	Rated Voltage (V) Max
	Min	Typ						
PE-1210AGCXXXSTS	**Operating Temperature Range -40°C to +125°C**							
PE-1210AGC110STS	300	550	11	+/-30%	0.4	300	10	80
PE-1210AGC220STS	500	1100	22	+/-30%	0.5	250	10	80
PE-1210AGC510STS	1000	2600	51	+/-30%	1.5	200	10	80
PE-1210AGC101STS	2200	5100	100	+/-30%	2.0	150	10	80
PE-1812AGCXXXSTS	**Operating Temperature Range -40°C to +125°C**							
PE-1812AGC110STS	300	600	11	+/-30%	0.6	360	10	50
PE-1812AGC220STS	600	1200	22	+/-30%	1.0	310	10	50
PE-1812AGC510STS	1500	3500	51	+/-30%	1.0	230	10	50
PE-1812AGC101STS	3000	7500	100	+/-30%	2.0	150	10	50

MECHANICAL

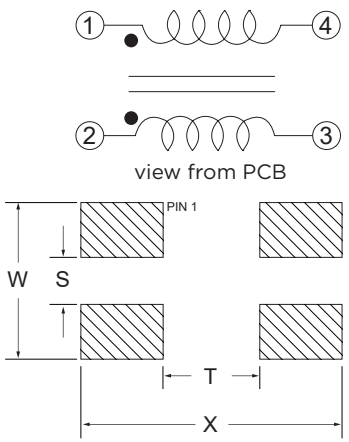




All Units in mm



SCHEMATIC



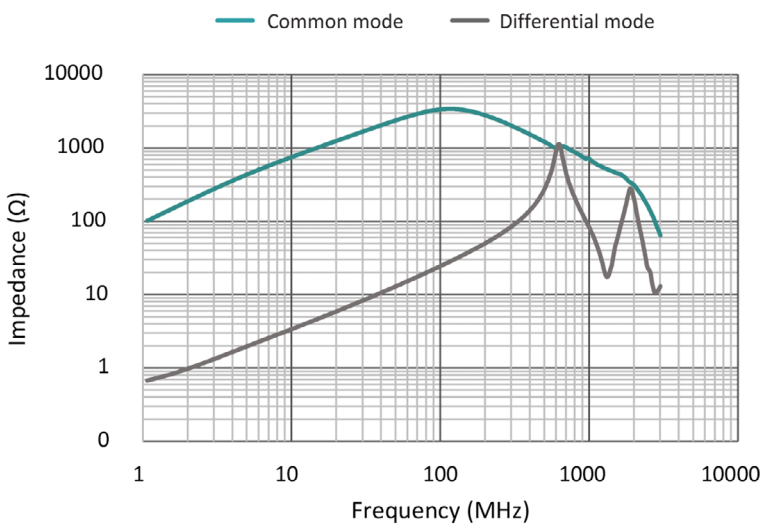
Component Dimensions (mm)								SOLDER PAD (mm)			
Series	A	B	C	D	E1	E2	F	X	T	W	S
1210 AGC	3.2 +/-0.20	2.5 +/-0.20	2.40 +/-0.20	0.15 ref.	0.70+ / -0.20	0.95+ / -0.20	0.40 ref.	3.60	1.60	2.70	0.60
1812 AGC	4.5 +/-0.20	3.2 +/-0.20	3.05 +/-0.20	0.15 ref.	0.75+ / -0.20	0.95+ / -0.20	1.50 ref.	5.00	2.80	3.40	1.10

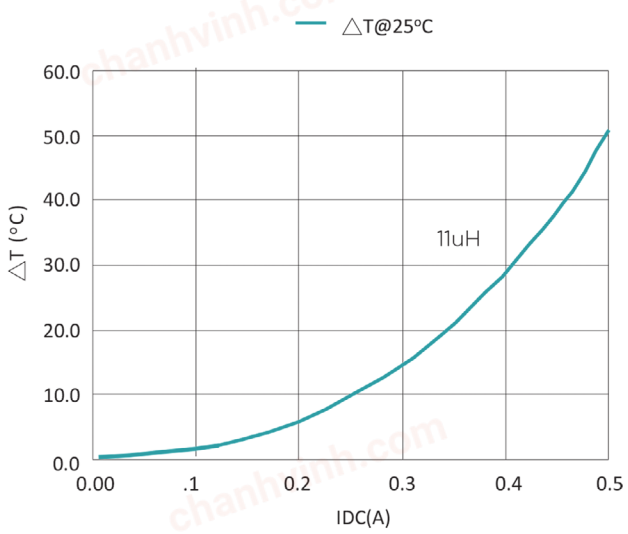
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Impedance vs Frequency

Temp vs DC Current

PE-1210AGC110STS

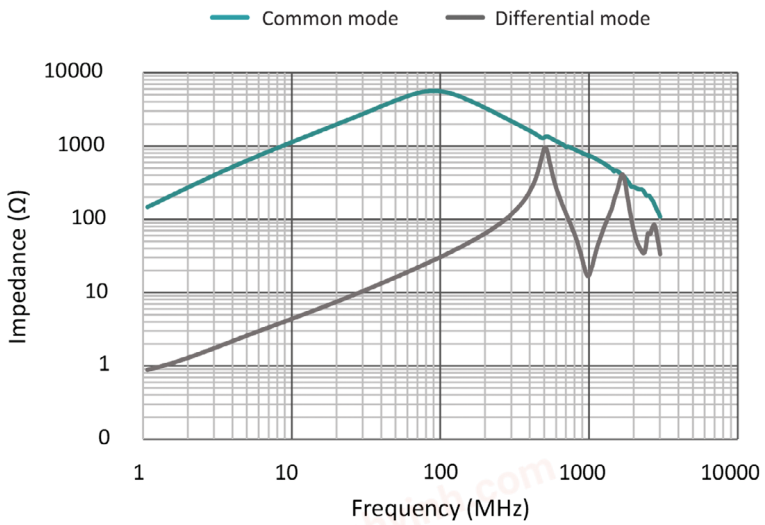


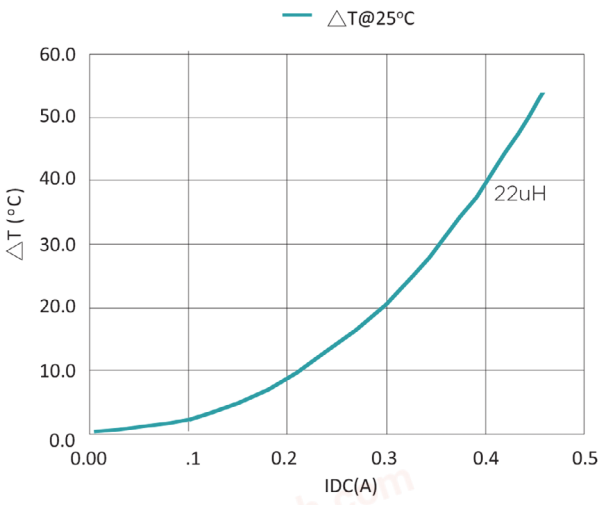


Impedance vs Frequency

Temp vs DC Current

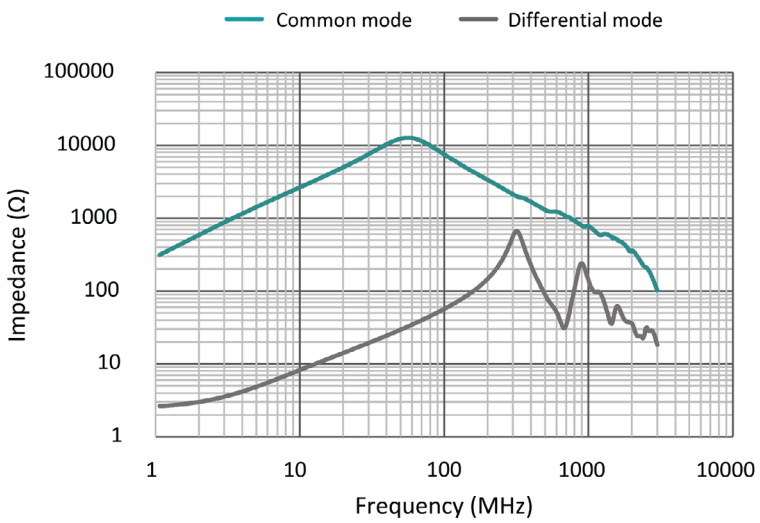
PE-1210AGC220STS



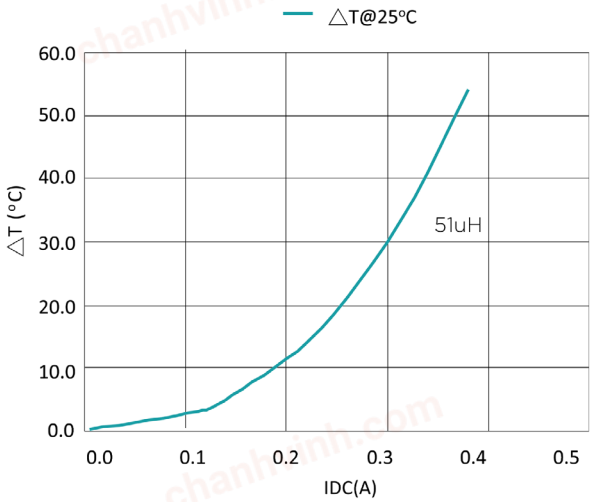


Impedance vs Frequency

PE-1210AGC510STS

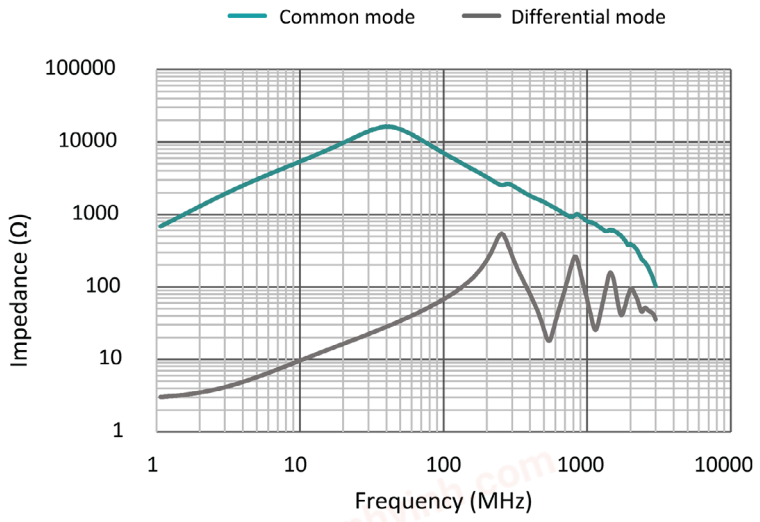


Temp vs DC Current

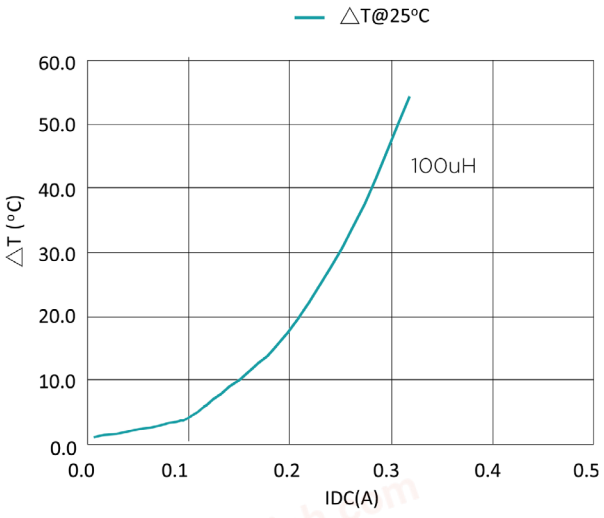


Impedance vs Frequency

PE-1210AGC101STS



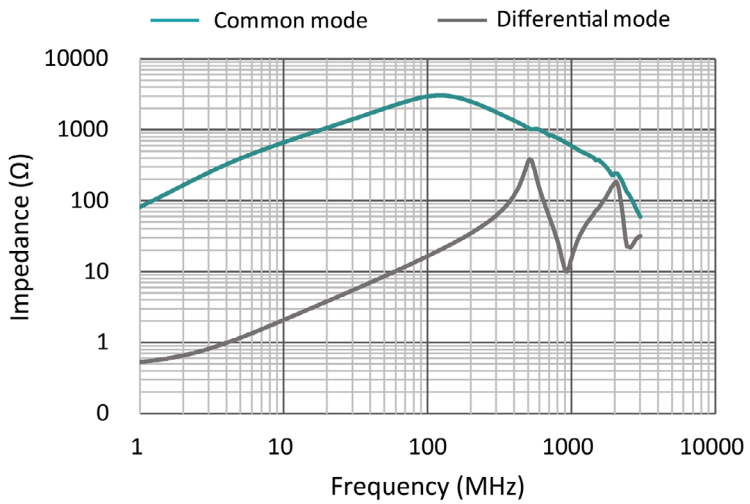
Temp vs DC Current



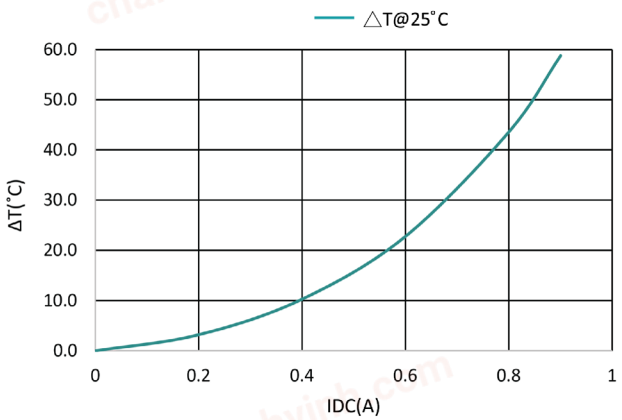
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Impedance vs Frequency

PE-1812AGC110STS

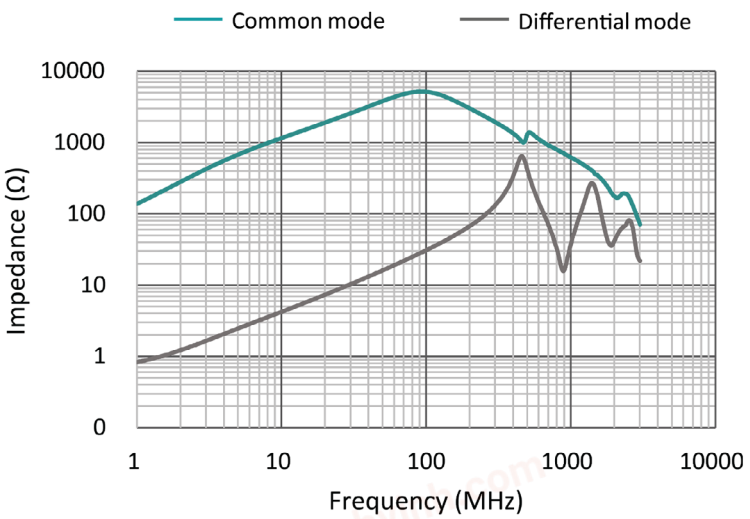


Temp vs DC Current

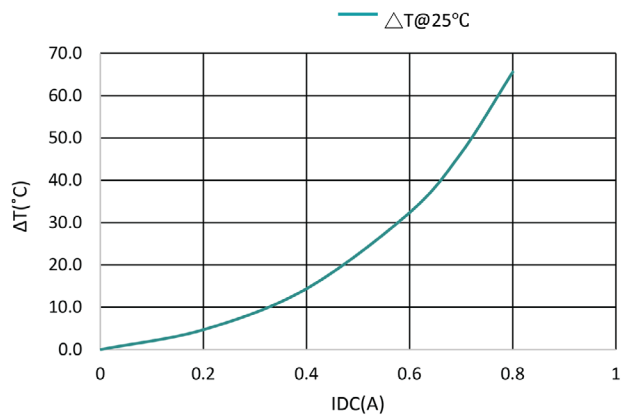


Impedance vs Frequency

PE-1812AGC220STS



Temp vs DC Current

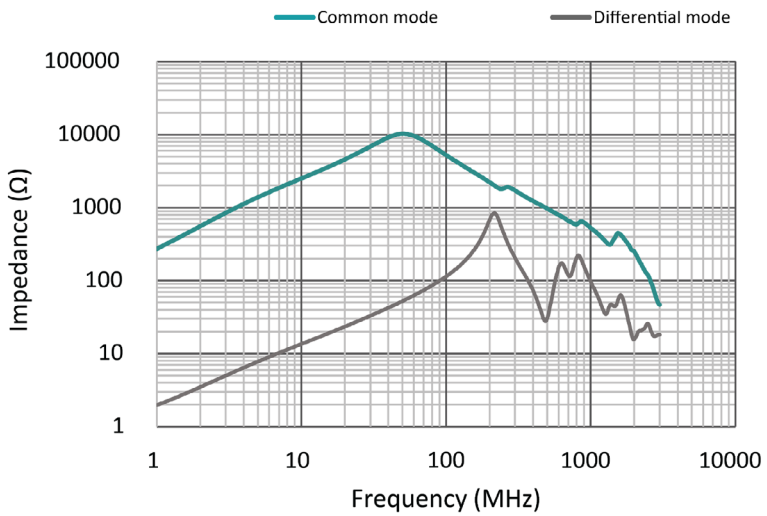


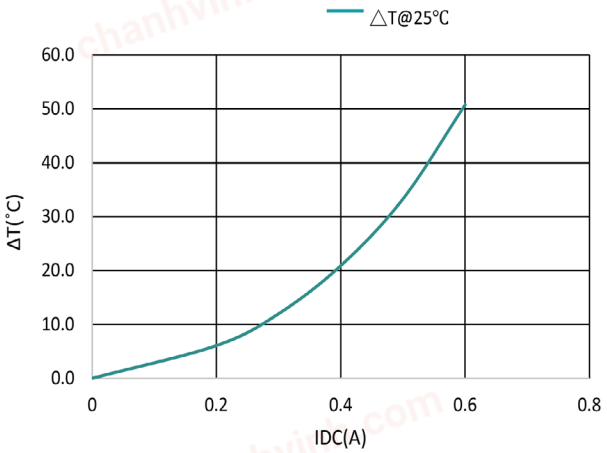
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Impedance vs Frequency

Temp vs DC Current

PE-1812AGC510STS

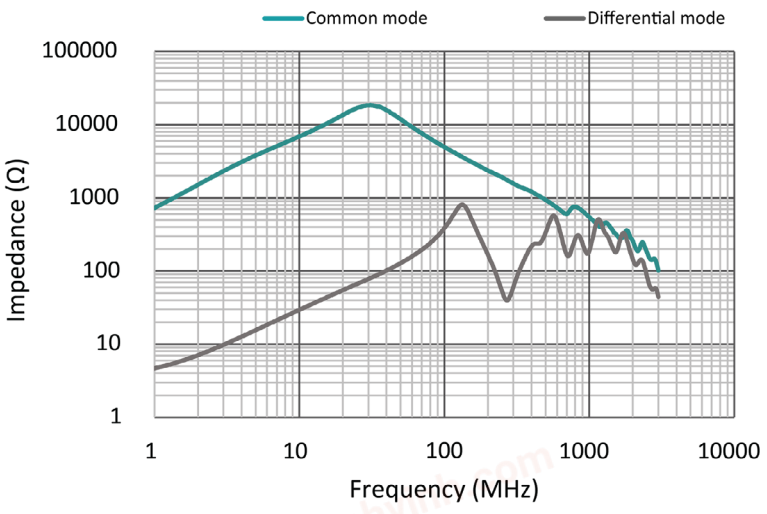


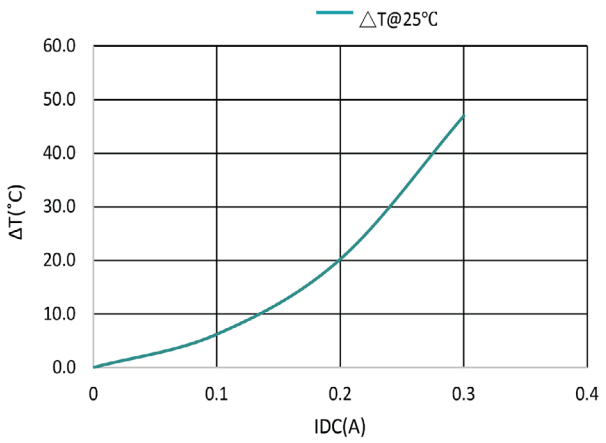


Impedance vs Frequency

Temp vs DC Current

PE-1812AGC101STS





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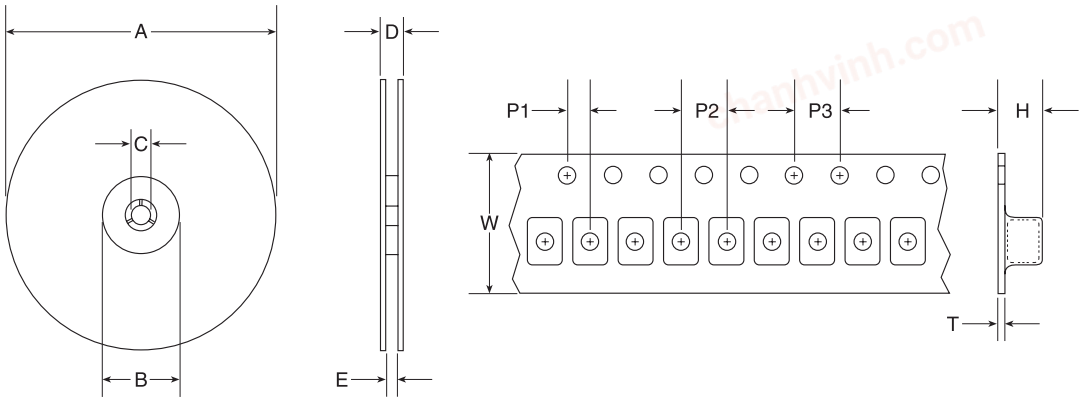
Reliability Test

Item	Reference documents	Test Condition	Test Specification
1. High Temperature Exposure	MIL-STD-202 Method 108	1. Temperature: 125°C 2. Time: 1000 hours	1. No mechanical and electrical damage 2. Inductance shall be within specification
2. Temperature Cycling	JESD22 Method JA-104	1. Temperature: -40°C~125°C 2. Number of cycles: 1000 cycle 3. Dwell time: 30 minutes	1. No mechanical and electrical damage 2. Inductance shall be within specification
3. Biased Humidity Test	MIL-STD-202 Method 103	1. Temperature: 85±5°C 2. Time: 1000 hours 3. Humidity: 85±5% RH	1. No mechanical and electrical damage 2. Inductance shall be within specification
4. Operational Life	MIL-PRF-27	1. Temperature: 125°C 2. Time: 1000 hours 3. Apply DC current reference	1. No mechanical and electrical damage 2. Inductance shall be within specification
5. External Visual	MIL-STD-883 Method 2009	Inspect product construction, marking and workmanship	Per product specification standard
6. Physical Dimensions	JESD22 Method JB-100	Verify physical dimensions to the applicable product detail specification	Per product specification standard
7. Mechanical Shock	MIL-STD-202 Method 213	Pulse shape: Half-sine waveform Impact acceleration: 100g Pulse duration: 6ms	1. No mechanical and electrical damage 2. Inductance shall be within specification
8. Vibration Test	MIL-STD-202 Method 204	1. Frequency and Amplified: 10-2000-10 Hz, 1.5mm 2. Direction: X, Y, Z 3. Test duration: 2 hours for each direction, 6 hours in total	The forces applied on the right conditions must not damage the terminal electrode and the ferrite
9. Resistance to Soldering Heat Test	MIL-STD-202 Method 210	1. Temperature: 260±5°C 2. Time: 10±1s	1. No mechanical and electrical damage 2. Inductance shall be within specification
10. Solderability Test	J-STD-002	1. 8 hours steam age test 2. Soldering: 245±5°C, for 5±1Sec.	The terminal shall be at least 95% covered with fresh solder.
11. Electrical Characterization	User Spec.	1. Operating temperature:-40°C±125°C 2. Room Temperature: 25°C	1. No mechanical and electrical damage 2. Inductance shall be within specification
12. Board Flex	AEC-Q200-005	1. Epoxy - PCB (1.6mm) 2. Deflection 2mm (min) 3. Holding tim 60s minimum	1. During the test no breakdown. 2. The characteristic is normal after test.
13. Terminal Strength Test	AEC-Q200-006	1. Apply push force to samples mounted on PCB. 2. Force of 1.8 kg for 60±1 seconds.	After test, inductors shall be on mechanical damge.

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Tape and Reel Specifications

CARRIER TAPE - SEE TABLES BELOW



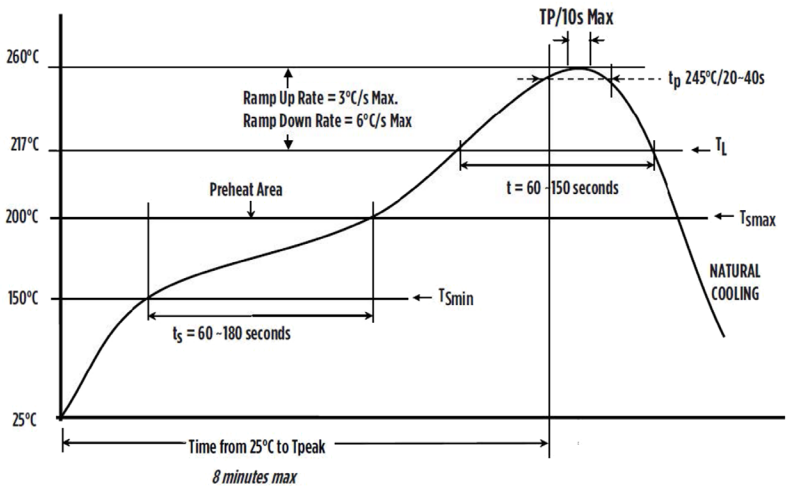
Reel Dimensions (mm)							Tape Dimensions (mm)					
Series	Parts per Reel	A	B	C	D	E	W	P1	P2	P3	H	T
1210 AGC	2000	330	103	13.5	16.5	12.5	12.0	2.0	8.0	4.0	2.70	0.30
1812 AGC	2000	330	103	13.5	16.5	12.5	12.0	2.0	8.0	4.0	3.60	0.30

III. Description:

a. Ferrite drum core construction
b. Magnetically shielded
c. Enameled copper wire: H class
d. Product weight: 0.15g (ref.)
e. Moisture sensitivity Level 1
f. Products comply with RoHS' requirements
g. Halogen Free available

IV. General specification:

a. Storage temp: -40°C to +125°C
b. Operating temp: -40°C to +125°C (Temp. rise included)
c. Resistance to solder heat: 250°C 10 secs.



For More Information:
Americas - prodinfo_network_americas@yageo.com | **Europe -** prodinfo_network_emea@yageo.com | **Asia -** prodinfo_network_asia@yageo.com

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